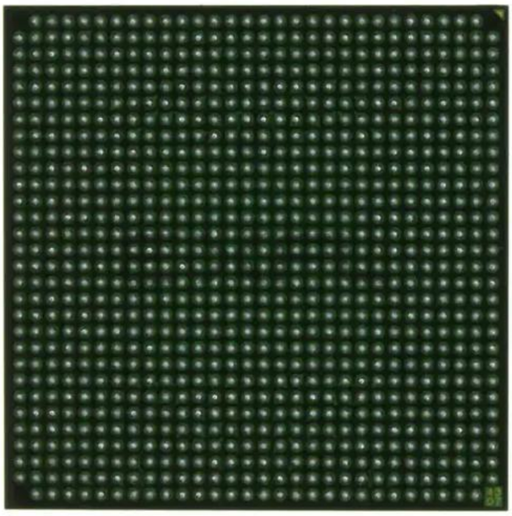

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Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	2688
Number of Logic Elements/Cells	-
Total RAM Bits	1032192
Number of I/O	624
Number of Gates	2000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	896-BBGA, FCBGA
Supplier Device Package	896-FCBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v2000-4ffg896i

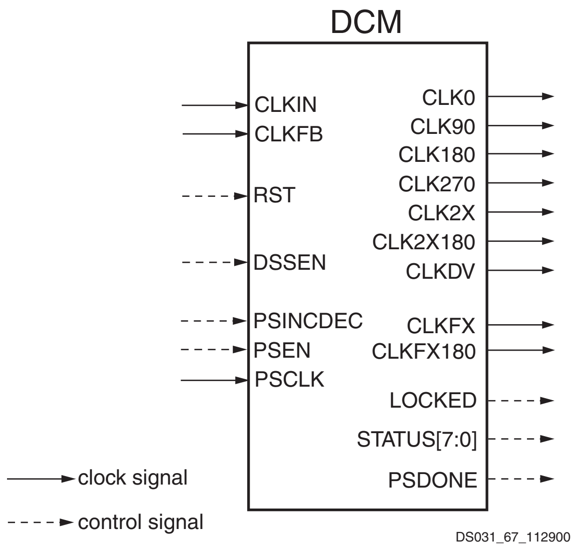


Figure 45: **Digital Clock Manager**

The DCM can be configured to delay the completion of the Virtex-II configuration process until after the DCM has achieved lock. This guarantees that the chip does not begin operating until after the system clocks generated by the DCM have stabilized.

The DCM has the following general control signals:

- RST input pin: resets the entire DCM
- LOCKED output pin: asserted High when all enabled DCM circuits have locked.
- STATUS output pins (active High): shown in Table 21.

Table 21: **DCM Status Pins**

Status Pin	Function
0	Phase Shift Overflow
1	CLKIN Stopped
2	CLKFX Stopped
3	N/A
4	N/A
5	N/A
6	N/A
7	N/A

Clock De-Skew

The DCM de-skews the output clocks relative to the input clock by automatically adjusting a digital delay line. Additional delay is introduced so that clock edges arrive at internal registers and block RAMs simultaneously with the clock edges arriving at the input clock pad. Alternatively, external clocks, which are also de-skewed relative to the input clock, can be generated for board-level routing. All DCM output clocks are phase-aligned to CLK0 and, therefore, are also phase-aligned to the input clock.

To achieve clock de-skew, the CLKFB input must be connected, and its source must be either CLK0 or CLK2X. Note that CLKFB must always be connected, unless only the CLKFX or CLKFX180 outputs are used and de-skew is not required.

Frequency Synthesis

The DCM provides flexible methods for generating new clock frequencies. Each method has a different operating frequency range and different AC characteristics. The CLK2X and CLK2X180 outputs double the clock frequency. The CLKDV output creates divided output clocks with division options of 1.5, 2, 2.5, 3, 3.5, 4, 4.5, 5, 5.5, 6, 6.5, 7, 7.5, 8, 9, 10, 11, 12, 13, 14, 15, and 16.

The CLKFX and CLKFX180 outputs can be used to produce clocks at the following frequency:

$$FREQ_{CLKFX} = (M/D) * FREQ_{CLKIN}$$

where M and D are two integers. Specifications for M and D are provided under DCM Timing Parameters in Module 3. By default, M=4 and D=1, which results in a clock output frequency four times faster than the clock input frequency (CLKIN).

CLK2X180 is phase shifted 180 degrees relative to CLK2X. CLKFX180 is phase shifted 180 degrees relative to CLKFX. All frequency synthesis outputs automatically have 50/50 duty cycles (with the exception of the CLKDV output when performing a non-integer divide in high-frequency mode).

Note that CLK2X and CLK2X180 are not available in high-frequency mode.

Phase Shifting

The DCM provides additional control over clock skew through either coarse or fine-grained phase shifting. The CLK0, CLK90, CLK180, and CLK270 outputs are each phase shifted by ¼ of the input clock period relative to each other, providing coarse phase control. Note that CLK90 and CLK270 are not available in high-frequency mode.

Fine-phase adjustment affects all nine DCM output clocks. When activated, the phase shift between the rising edges of CLKIN and CLKFB is a specified fraction of the input clock period.

In variable mode, the PHASE_SHIFT value can also be dynamically incremented or decremented as determined by PSINCDEC synchronously to PSCLK, when the PSEN input is active. Figure 46 illustrates the effects of fine-phase shifting. For more information on DCM features, see the Virtex-II *User Guide*.

Virtex-II Pin-to-Pin Output Parameter Guidelines

All devices are 100% functionally tested. Listed below are representative values for typical pin locations and normal clock loading. Values are expressed in nanoseconds unless otherwise noted.

Global Clock Input to Output Delay for LVTTL, 12 mA, Fast Slew Rate, *With* DCM

Table 34: **Global Clock Input to Output Delay for LVTTL, 12 mA, Fast Slew Rate, *With* DCM**

Description	Symbol	Device	Speed Grade			Units
			-6	-5	-4	
LVTTL Global Clock Input to Output delay using Output flip-flop, 12 mA, Fast Slew Rate, *with* DCM. For data *output* with different standards, adjust the delays with the values shown in IOB Output Switching Characteristics Standard Adjustments, page 14.						
Global Clock and OFF with DCM	$T_{ICKOFDCM}$	XC2V40	1.10	1.28	1.48	ns
		XC2V80	1.10	1.28	1.48	ns
		XC2V250	1.10	1.28	1.48	ns
		XC2V500	1.10	1.28	1.48	ns
		XC2V1000	1.10	1.28	1.48	ns
		XC2V1500	1.10	1.28	1.48	ns
		XC2V2000	1.10	1.28	1.48	ns
		XC2V3000	1.19	1.38	1.59	ns
		XC2V4000	1.19	1.38	1.59	ns
		XC2V6000	1.64	1.88	2.17	ns
		XC2V8000		1.88	2.17	ns

Notes:
1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. Output timing is measured at 50% V_{CC} threshold with test setup shown in Figure 1. For other I/O standards, see Table 19.

DCM Timing Parameters

All devices are 100% functionally tested. Because of the difficulty in directly measuring many internal timing parameters, those parameters are derived from benchmark timing patterns. The following guidelines reflect worst-case values across the recommended operating conditions. All output jitter and phase specifications are determined through statistical measurement at the package pins.

Operating Frequency Ranges

Table 38: **Operating Frequency Ranges**

Description	Symbol	Constraints	Speed Grade			Units
			-6	-5	-4	
Output Clocks (Low Frequency Mode)						
CLK0, CLK90, CLK180, CLK270	CLKOUT_FREQ_1X_LF_Min		24.00	24.00	24.00	MHz
	CLKOUT_FREQ_1X_LF_Max		230.00	210.00	180.00	MHz
CLK2X, CLK2X180	CLKOUT_FREQ_2X_LF_Min		48.00	48.00	48.00	MHz
	CLKOUT_FREQ_2X_LF_Max		450.00	420.00	360.00	MHz
CLKDV	CLKOUT_FREQ_DV_LF_Min		1.50	1.50	1.50	MHz
	CLKOUT_FREQ_DV_LF_Max		150.00	140.00	120.00	MHz
CLKFX, CLKFX180	CLKOUT_FREQ_FX_LF_Min		24.00	24.00	24.00	MHz
	CLKOUT_FREQ_FX_LF_Max		260.00	240.00	210.00	MHz
Input Clocks (Low Frequency Mode)						
CLKIN (using DLL outputs) [1,3,4]	CLKIN_FREQ_DLL_LF_Min		24.00	24.00	24.00	MHz
	CLKIN_FREQ_DLL_LF_Max		230.00	210.00	180.00	MHz
CLKIN (using CLKFX outputs) [2,3,4]	CLKIN_FREQ_FX_LF_Min		1.00	1.00	1.00	MHz
	CLKIN_FREQ_FX_LF_Max		260.00	240.00	210.00	MHz
PSCLK	PSCLK_FREQ_LF_Min		0.01	0.01	0.01	MHz
	PSCLK_FREQ_LF_Max		450.00	420.00	360.00	MHz
Output Clocks (High Frequency Mode)						
CLK0, CLK180	CLKOUT_FREQ_1X_HF_Min		48.00	48.00	48.00	MHz
	CLKOUT_FREQ_1X_HF_Max		450.00	420.00	360.00	MHz
CLKDV	CLKOUT_FREQ_DV_HF_Min		3.00	3.00	3.00	MHz
	CLKOUT_FREQ_DV_HF_Max		300.00	280.00	240.00	MHz
CLKFX, CLKFX180	CLKOUT_FREQ_FX_HF_Min		210.00	210.00	210.00	MHz
	CLKOUT_FREQ_FX_HF_Max		350.00	320.00	270.00	MHz
Input Clocks (High Frequency Mode)						
CLKIN (using DLL outputs) [1,3,4]	CLKIN_FREQ_DLL_HF_Min		48.00	48.00	48.00	MHz
	CLKIN_FREQ_DLL_HF_Max		450.00	420.00	360.00	MHz
CLKIN (using CLKFX outputs) [2,3,4]	CLKIN_FRQ_FX_HF_Min		50.00	50.00	50.00	MHz
	CLKIN_FRQ_FX_HF_Max		350.00	320.00	270.00	MHz
PSCLK	PSCLK_FREQ_HF_Min		0.01	0.01	0.01	MHz
	PSCLK_FREQ_HF_Max		450.00	420.00	360.00	MHz

Notes:
1. "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. If both DLL and CLKFX outputs are used, follow the more restrictive specification.
3. If the CLKIN_DIVIDE_BY_2 attribute of the DCM is used, then double these values.
4. If the CLKIN_DIVIDE_BY_2 attribute of the DCM is used and CLKIN frequency > 400 MHz, CLKIN duty cycle must be within ±5% (45/55 to 55/45).

Miscellaneous Timing Parameters

Table 42: **Miscellaneous Timing Parameters**

Description	Symbol	Constraints F_{CLKIN}	Speed Grade			Units
			-6	-5	-4	
Time Required to Achieve LOCK						
Using DLL outputs(1)	LOCK_DLL					
	LOCK_DLL_60	> 60MHz	20.0	20.0	20.0	µs
	LOCK_DLL_50_60	50 - 60 MHz	25.0	25.0	25.0	µs
	LOCK_DLL_40_50	40 - 50 MHz	50.0	50.0	50.0	µs
	LOCK_DLL_30_40	30 - 40 MHz	90.0	90.0	90.0	µs
	LOCK_DLL_24_30	24 - 30 MHz	120.0	120.0	120.0	µs
Using CLKFX outputs	LOCK_FX_MIN		10.0	10.0	10.0	ms
	LOCK_FX_MAX		10.0	10.0	10.0	ms
Additional lock time with fine-phase shifting	LOCK_DLL_FINE_SHIFT		50.0	50.0	50.0	µs
Fine-Phase Shifting						
Absolute shifting range	FINE_SHIFT_RANGE		10.0	10.0	10.0	ns
Delay Lines						
Tap delay resolution	DCM_TAP_MIN		30.0	30.0	30.0	ps
	DCM_TAP_MAX		60.0	60.0	60.0	ps

Notes:
1. "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. Specification also applies to PSCLK.

Frequency Synthesis

Table 43: **Frequency Synthesis**

Attribute	Min	Max
CLKFX_MULTIPLY	2	32
CLKFX_DIVIDE	1	32

Parameter Cross Reference

Table 44: **Parameter Cross Reference**

Libraries Guide	Data Sheet
DLL_CLKOUT_{MIN|MAX}_LF	CLKOUT_FREQ_{1X|2X|DV}_LF
DFS_CLKOUT_{MIN|MAX}_LF	CLKOUT_FREQ_FX_LF
DLL_CLKIN_{MIN|MAX}_LF	CLKIN_FREQ_DLL_LF
DFS_CLKIN_{MIN|MAX}_LF	CLKIN_FREQ_FX_LF
DLL_CLKOUT_{MIN|MAX}_HF	CLKOUT_FREQ_{1X|DV}_HF
DFS_CLKOUT_{MIN|MAX}_HF	CLKOUT_FREQ_FX_HF
DLL_CLKIN_{MIN|MAX}_HF	CLKIN_FREQ_DLL_HF
DFS_CLKIN_{MIN|MAX}_HF	CLKIN_FREQ_FX_HF

Pin Definitions

Table 4 provides a description of each pin type listed in Virtex-II pinout tables.

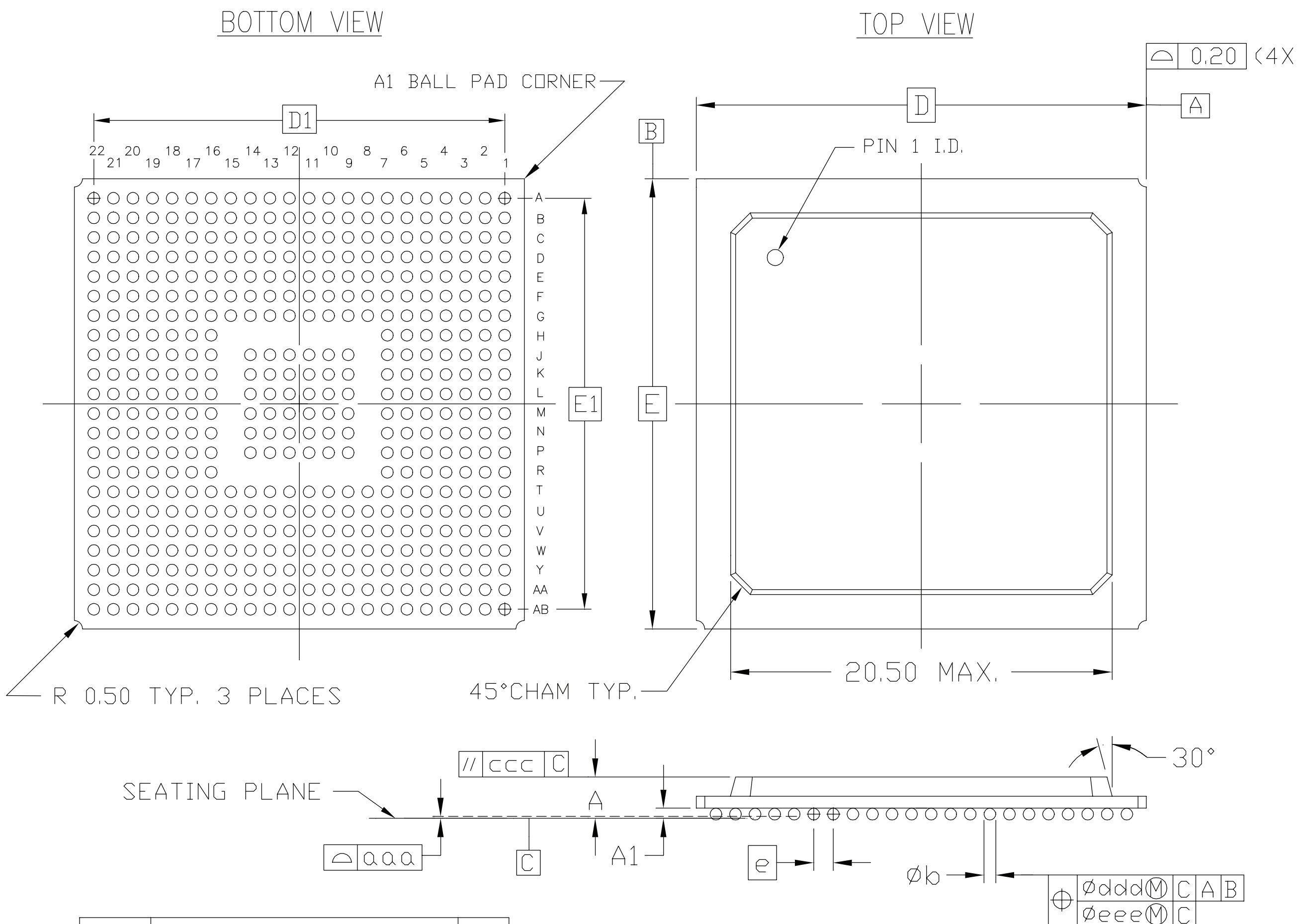
Table 4: **Virtex-II Pin Definitions**

Pin Name	Direction	Description
User I/O Pins		
IO_LXXY_#	Input/Output/ Bidirectional	All user I/O pins are capable of differential signalling and can implement LVDS, ULVDS, BLVDS, LVPECL, or LDT pairs. Each user I/O is labeled "**IO_LXXY_#**", where: **IO** indicates a user I/O pin. **LXXY** indicates a differential pair, with **XX** a unique pair in the bank and **Y = P/N** for the positive and negative sides of the differential pair. **#** indicates the bank number (0 through 7)
Dual-Function Pins		
IO_LXXY_#/ZZZ		The dual-function pins are labelled "**IO_LXXY_#/ZZZ**", where **ZZZ** can be one of the following pins: Per Bank - **VRP, VRN,** or **VREF** Globally - **GCLKX(S/P), BUSY/DOUT, INIT_B, D0/DIN – D7, RDWR_B,** or **CS_B**
With /ZZZ:		
D0/DIN, D1, D2, D3, D4, D5, D6, D7	Input/Output	• *In* SelectMAP *mode,* D0 through D7 are configuration data pins. These pins become user I/Os after configuration, unless the SelectMAP port is retained. • *In bit-serial modes,* DIN (D0) is the single-data input. This pin becomes a user I/O after configuration.
CS_B	Input	In SelectMAP mode, this is the active-low Chip Select signal. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained.
RDWR_B	Input	In SelectMAP mode, this is the active-low Write Enable signal. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained.
BUSY/DOUT	Output	• *In* SelectMAP *mode,* BUSY controls the rate at which configuration data is loaded. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained. • *In bit-serial modes,* DOUT provides preamble and configuration data to downstream devices in a daisy-chain. The pin becomes a user I/O after configuration.
INIT_B	Bidirectional (open-drain)	When Low, this pin indicates that the configuration memory is being cleared. When held Low, the start of configuration is delayed. During configuration, a Low on this output indicates that a configuration data error has occurred. The pin becomes a user I/O after configuration.
GCLKx (S/P)	Input/Output	These are clock input pins that connect to Global Clock Buffers. These pins become regular user I/Os when not needed for clocks.
VRP	Input	This pin is for the DCI voltage reference resistor of P transistor (per bank).
VRN	Input	This pin is for the DCI voltage reference resistor of N transistor (per bank).
ALT_VRP	Input	This is the alternative pin for the DCI voltage reference resistor of P transistor.
ALT_VRN	Input	This is the alternative pin for the DCI voltage reference resistor of N transistor.
V_{REF}	Input	These are input threshold voltage pins. They become user I/Os when an external threshold voltage is not needed (per bank).
Dedicated Pins(1)		
CCLK	Input/Output	Configuration clock. Output in Master mode or Input in Slave mode.

Table 6: **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
7	IO_L45N_7	F5	NC	NC
7	IO_L43P_7	F1	NC	NC
7	IO_L43N_7	F2	NC	NC
7	IO_L06P_7	F3	NC	
7	IO_L06N_7	F4	NC	
7	IO_L04P_7	E1	NC	
7	IO_L04N_7	E2	NC	
7	IO_L03P_7/VREF_7	E3		
7	IO_L03N_7	E4		
7	IO_L02P_7/VRN_7	D2		
7	IO_L02N_7/VRP_7	D3		
7	IO_L01P_7	D1		
7	IO_L01N_7	C1		
0	VCCO_0	F8		
0	VCCO_0	F7		
0	VCCO_0	E8		
1	VCCO_1	F10		
1	VCCO_1	F9		
1	VCCO_1	E9		
2	VCCO_2	H12		
2	VCCO_2	H11		
2	VCCO_2	G11		
3	VCCO_3	K11		
3	VCCO_3	J12		
3	VCCO_3	J11		
4	VCCO_4	M9		
4	VCCO_4	L10		
4	VCCO_4	L9		
5	VCCO_5	M8		
5	VCCO_5	L8		
5	VCCO_5	L7		
6	VCCO_6	K6		
6	VCCO_6	J6		

FG456/FGG456 Fine-Pitch BGA Package Specifications (1.00mm pitch)



SYMBOL	MILLIMETERS MIN.	NOM.	MAX.	NOTE
A	~	~	2.60	3
A_1	0.35	0.50	0.60	
D/E	23.00 BSC			
D_1/E_1	21.00 REF			
e	1.00 BSC			
Øb	0.50	0.60	0.70	
aaa	~	~	0.20	
ccc	~	~	0.35	
ddd	~	~	0.30	
eee	~	~	0.10	
M	22			2

NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1994
2. SYMBOL 'M' IS THE BALL MATRIX SIZE.
3. NOMINAL 'A' DIMENSION FOR 2-LAYER IS 2.03mm AND FOR 4-LAYER IS 2.20mm.
4. CONFORMS TO JEDEC MS-034-AAJ-1 (DEPOPULATED)

456-BALL FINE PITCH BGA (FG456/FGG456)

Figure 3: **FG456/FGG456 Fine-Pitch BGA Package Specifications**

FG676/FGG676 Fine-Pitch BGA Package

As shown in Table 8, XC2V1500, XC2V2000, and XC2V3000 Virtex-II devices are available in the FG676/FGG676 fine-pitch BGA package. Pins in the XC2V1500, XC2V2000, and XC2V3000 devices are the same, except for the pin differences in the XC2V1500 and XC2V2000 devices shown in the No Connect columns. Following this table are the FG676/FGG676 Fine-Pitch BGA Package Specifications (1.00mm pitch).

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
0	IO_L01N_0	D6		
0	IO_L01P_0	C6		
0	IO_L02N_0	B1		
0	IO_L02P_0	A2		
0	IO_L03N_0/VRP_0	D7		
0	IO_L03P_0/VRN_0	C7		
0	IO_L04N_0/VREF_0	B3		
0	IO_L04P_0	A3		
0	IO_L05N_0	G6		
0	IO_L05P_0	G7		
0	IO_L06N_0	E6		
0	IO_L06P_0	E7		
0	IO_L19N_0	B4		
0	IO_L19P_0	A4		
0	IO_L21N_0	B5		
0	IO_L21P_0/VREF_0	A5		
0	IO_L22N_0	B6		
0	IO_L22P_0	A6		
0	IO_L24N_0	A7		
0	IO_L24P_0	A8		
0	IO_L25N_0	E8	NC	NC
0	IO_L25P_0	D8	NC	NC
0	IO_L27N_0	G8	NC	NC
0	IO_L27P_0/VREF_0	F8	NC	NC
0	IO_L49N_0	C8		
0	IO_L49P_0	B8		
0	IO_L51N_0	D9		
0	IO_L51P_0/VREF_0	E9		
0	IO_L52N_0	F9		
0	IO_L52P_0	G9		
0	IO_L54N_0	B9		
0	IO_L54P_0	A9		
0	IO_L67N_0	C9		

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
6	IO_L52N_6	U1		
6	IO_L54P_6	U7		
6	IO_L54N_6	T7		
6	IO_L67P_6	U4		
6	IO_L67N_6	U3		
6	IO_L69P_6	U6		
6	IO_L69N_6/VREF_6	U5		
6	IO_L70P_6	T5		
6	IO_L70N_6	T6		
6	IO_L72P_6	T8		
6	IO_L72N_6	R8		
6	IO_L73P_6	T2	NC	
6	IO_L73N_6	T1	NC	
6	IO_L75P_6	T4	NC	
6	IO_L75N_6/VREF_6	T3	NC	
6	IO_L76P_6	R6	NC	
6	IO_L76N_6	R5	NC	
6	IO_L78P_6	R4	NC	
6	IO_L78N_6	R3	NC	
6	IO_L91P_6	R2		
6	IO_L91N_6	R1		
6	IO_L93P_6	R7		
6	IO_L93N_6/VREF_6	P7		
6	IO_L94P_6	P6		
6	IO_L94N_6	P5		
6	IO_L96P_6	P4		
6	IO_L96N_6	P3		
7	IO_L96P_7	P1		
7	IO_L96N_7	N1		
7	IO_L94P_7	N4		
7	IO_L94N_7	N5		
7	IO_L93P_7/VREF_7	N6		
7	IO_L93N_7	N7		
7	IO_L91P_7	P8		
7	IO_L91N_7	N8		
7	IO_L78P_7	M1	NC	

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
0	IO_L53N_0	G20		
0	IO_L53P_0	G19		
0	IO_L54N_0	D21		
0	IO_L54P_0	D22		
0	IO_L67N_0	E20	NC	
0	IO_L67P_0	E21	NC	
0	IO_L68N_0	H19	NC	
0	IO_L68P_0	H18	NC	
0	IO_L69N_0	D20	NC	
0	IO_L69P_0/VREF_0	D19	NC	
0	IO_L70N_0	A20	NC	
0	IO_L70P_0	A21	NC	
0	IO_L71N_0	F19	NC	
0	IO_L71P_0	F18	NC	
0	IO_L72N_0	C19	NC	
0	IO_L72P_0	C20	NC	
0	IO_L73N_0	B18	NC	NC
0	IO_L73P_0	B19	NC	NC
0	IO_L74N_0	G18	NC	NC
0	IO_L74P_0	H17	NC	NC
0	IO_L75N_0	E18	NC	NC
0	IO_L75P_0/VREF_0	D18	NC	NC
0	IO_L76N_0	A18	NC	NC
0	IO_L76P_0	A19	NC	NC
0	IO_L77N_0	J17	NC	NC
0	IO_L77P_0	J16	NC	NC
0	IO_L78N_0	E16	NC	NC
0	IO_L78P_0	E17	NC	NC
0	IO_L91N_0/VREF_0	B17		
0	IO_L91P_0	B16		
0	IO_L92N_0	F17		
0	IO_L92P_0	F16		
0	IO_L93N_0	D16		
0	IO_L93P_0	D17		
0	IO_L94N_0/VREF_0	A17		
0	IO_L94P_0	A16		
0	IO_L95N_0/GCLK7P	H16		

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
0	IO_L95P_0/GCLK6S	G16		
0	IO_L96N_0/GCLK5P	C17		
0	IO_L96P_0/GCLK4S	C16		
1	IO_L96N_1/GCLK3P	C15		
1	IO_L96P_1/GCLK2S	C14		
1	IO_L95N_1/GCLK1P	F15		
1	IO_L95P_1/GCLK0S	F14		
1	IO_L94N_1	B15		
1	IO_L94P_1/VREF_1	B14		
1	IO_L93N_1	D14		
1	IO_L93P_1	D15		
1	IO_L92N_1	G15		
1	IO_L92P_1	H15		
1	IO_L91N_1	A14		
1	IO_L91P_1/VREF_1	A13		
1	IO_L78N_1	E14	NC	NC
1	IO_L78P_1	E15	NC	NC
1	IO_L77N_1	J15	NC	NC
1	IO_L77P_1	J14	NC	NC
1	IO_L76N_1	B12	NC	NC
1	IO_L76P_1	B13	NC	NC
1	IO_L75N_1/VREF_1	D13	NC	NC
1	IO_L75P_1	E13	NC	NC
1	IO_L74N_1	H14	NC	NC
1	IO_L74P_1	H13	NC	NC
1	IO_L73N_1	A11	NC	NC
1	IO_L73P_1	A12	NC	NC
1	IO_L72N_1	C11	NC	
1	IO_L72P_1	C12	NC	
1	IO_L71N_1	F13	NC	
1	IO_L71P_1	F12	NC	
1	IO_L70N_1	B10	NC	
1	IO_L70P_1	B11	NC	
1	IO_L69N_1/VREF_1	D12	NC	
1	IO_L69P_1	D11	NC	
1	IO_L68N_1	G13	NC	

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
4	IO_L19N_4	AK6		
4	IO_L19P_4	AK5		
4	IO_L20N_4	AE9		
4	IO_L20P_4	AE10		
4	IO_L21N_4	AF7		
4	IO_L21P_4/VREF_4	AF8		
4	IO_L22N_4	AK7		
4	IO_L22P_4	AJ6		
4	IO_L23N_4	AD10		
4	IO_L23P_4	AD11		
4	IO_L24N_4	AG8		
4	IO_L24P_4	AG7		
4	IO_L49N_4	AJ8		
4	IO_L49P_4	AJ7		
4	IO_L50N_4	AE11		
4	IO_L50P_4	AE12		
4	IO_L51N_4	AG9		
4	IO_L51P_4/VREF_4	AG10		
4	IO_L52N_4	AK9		
4	IO_L52P_4	AJ9		
4	IO_L53N_4	AH8		
4	IO_L53P_4	AH9		
4	IO_L54N_4	AF11		
4	IO_L54P_4	AF10		
4	IO_L67N_4	AJ11	NC	
4	IO_L67P_4	AJ10	NC	
4	IO_L68N_4	AC12	NC	
4	IO_L68P_4	AC13	NC	
4	IO_L69N_4	AG11	NC	
4	IO_L69P_4/VREF_4	AG12	NC	
4	IO_L70N_4	AK11	NC	
4	IO_L70P_4	AK10	NC	
4	IO_L71N_4	AD12	NC	
4	IO_L71P_4	AD13	NC	
4	IO_L72N_4	AH12	NC	
4	IO_L72P_4	AH11	NC	
4	IO_L73N_4	AJ13	NC	NC

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
7	IO_L95N_7	R24		
7	IO_L94P_7	R29		
7	IO_L94N_7	T29		
7	IO_L93P_7/VREF_7	R27		
7	IO_L93N_7	P27		
7	IO_L92P_7	R23		
7	IO_L92N_7	P23		
7	IO_L91P_7	N30		
7	IO_L91N_7	P30		
7	IO_L78P_7	P26	NC	NC
7	IO_L78N_7	R26	NC	NC
7	IO_L77P_7	R22	NC	NC
7	IO_L77N_7	P22	NC	NC
7	IO_L76P_7	N29	NC	NC
7	IO_L76N_7	P29	NC	NC
7	IO_L75P_7/VREF_7	N27	NC	NC
7	IO_L75N_7	N26	NC	NC
7	IO_L74P_7	P25	NC	NC
7	IO_L74N_7	N25	NC	NC
7	IO_L73P_7	L30	NC	NC
7	IO_L73N_7	M30	NC	NC
7	IO_L72P_7	L28	NC	
7	IO_L72N_7	M28	NC	
7	IO_L71P_7	N24	NC	
7	IO_L71N_7	M24	NC	
7	IO_L70P_7	L29	NC	
7	IO_L70N_7	M29	NC	
7	IO_L69P_7/VREF_7	M27	NC	
7	IO_L69N_7	L27	NC	
7	IO_L68P_7	N23	NC	
7	IO_L68N_7	M23	NC	
7	IO_L67P_7	J30	NC	
7	IO_L67N_7	K30	NC	
7	IO_L54P_7	K26		
7	IO_L54N_7	L26		
7	IO_L53P_7	M25		
7	IO_L53N_7	L25		

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
NA	GND	AE32	
NA	GND	AE3	
NA	GND	AC30	
NA	GND	AC5	
NA	GND	AA28	
NA	GND	AA21	
NA	GND	AA20	
NA	GND	AA19	
NA	GND	AA18	
NA	GND	AA17	
NA	GND	AA16	
NA	GND	AA15	
NA	GND	AA14	
NA	GND	AA7	
NA	GND	Y33	
NA	GND	Y21	
NA	GND	Y20	
NA	GND	Y19	
NA	GND	Y18	
NA	GND	Y17	
NA	GND	Y16	
NA	GND	Y15	
NA	GND	Y14	
NA	GND	Y2	
NA	GND	W26	
NA	GND	W21	
NA	GND	W20	
NA	GND	W19	
NA	GND	W18	
NA	GND	W17	
NA	GND	W16	
NA	GND	W15	
NA	GND	W14	
NA	GND	W9	
NA	GND	V21	
NA	GND	V20	

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
NA	GND	V19	
NA	GND	V18	
NA	GND	V17	
NA	GND	V16	
NA	GND	V15	
NA	GND	V14	
NA	GND	U21	
NA	GND	U20	
NA	GND	U19	
NA	GND	U18	
NA	GND	U17	
NA	GND	U16	
NA	GND	U15	
NA	GND	U14	
NA	GND	T26	
NA	GND	T21	
NA	GND	T20	
NA	GND	T19	
NA	GND	T18	
NA	GND	T17	
NA	GND	T16	
NA	GND	T15	
NA	GND	T14	
NA	GND	T9	
NA	GND	R33	
NA	GND	R21	
NA	GND	R20	
NA	GND	R19	
NA	GND	R18	
NA	GND	R17	
NA	GND	R16	
NA	GND	R15	
NA	GND	R14	
NA	GND	R2	
NA	GND	P28	
NA	GND	P21	

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	IO_L93N_1	E19		
1	IO_L93P_1	E20		
1	IO_L92N_1	J19		
1	IO_L92P_1	J18		
1	IO_L91N_1	A18		
1	IO_L91P_1/VREF_1	A19		
1	IO_L84N_1	D18		
1	IO_L84P_1	D19		
1	IO_L83N_1	K19		
1	IO_L83P_1	K18		
1	IO_L82N_1	B18		
1	IO_L82P_1	B19		
1	IO_L81N_1/VREF_1	G18		
1	IO_L81P_1	G19		
1	IO_L80N_1	E18		
1	IO_L80P_1	E17		
1	IO_L79N_1	A16		
1	IO_L79P_1	A17		
1	IO_L78N_1	F17		
1	IO_L78P_1	F18		
1	IO_L77N_1	L19		
1	IO_L77P_1	L18		
1	IO_L76N_1	B16		
1	IO_L76P_1	B17		
1	IO_L75N_1/VREF_1	G16		
1	IO_L75P_1	G17		
1	IO_L74N_1	M19		
1	IO_L74P_1	M18		
1	IO_L73N_1	C16		
1	IO_L73P_1	C17		
1	IO_L72N_1	D15		
1	IO_L72P_1	D16		
1	IO_L71N_1	J17		
1	IO_L71P_1	J16		
1	IO_L70N_1	A14		
1	IO_L70P_1	A15		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	IO_L69N_1/VREF_1	E15		
1	IO_L69P_1	E16		
1	IO_L68N_1	K17		
1	IO_L68P_1	K16		
1	IO_L67N_1	C15		
1	IO_L67P_1	B15		
1	IO_L60N_1	F15		
1	IO_L60P_1	F16		
1	IO_L59N_1	H16		
1	IO_L59P_1	H15		
1	IO_L58N_1	C13		
1	IO_L58P_1	C14		
1	IO_L57N_1/VREF_1	D13		
1	IO_L57P_1	D14		
1	IO_L56N_1	M17		
1	IO_L56P_1	M16		
1	IO_L55N_1	A12		
1	IO_L55P_1	A13		
1	IO_L54N_1	B12		
1	IO_L54P_1	B13		
1	IO_L53N_1	G15		
1	IO_L53P_1	G14		
1	IO_L52N_1	C11		
1	IO_L52P_1	C12		
1	IO_L51N_1/VREF_1	F13		
1	IO_L51P_1	F14		
1	IO_L50N_1	L16		
1	IO_L50P_1	L15		
1	IO_L49N_1	A10		
1	IO_L49P_1	A11		
1	IO_L36N_1	E12	NC	
1	IO_L36P_1	E13	NC	
1	IO_L35N_1	K15	NC	
1	IO_L35P_1	J14	NC	
1	IO_L34N_1	B9	NC	
1	IO_L34P_1	B10	NC	

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
5	IO_L79N_5	AV24		
5	IO_L79P_5	AV23		
5	IO_L78N_5	AP23		
5	IO_L78P_5	AP22		
5	IO_L77N_5	AJ21		
5	IO_L77P_5	AJ22		
5	IO_L76N_5	AU24		
5	IO_L76P_5	AU23		
5	IO_L75N_5/VREF_5	AT25		
5	IO_L75P_5	AT24		
5	IO_L74N_5	AH21		
5	IO_L74P_5	AH22		
5	IO_L73N_5	AW26		
5	IO_L73P_5	AW25		
5	IO_L72N_5	AR25		
5	IO_L72P_5	AR24		
5	IO_L71N_5	AN23		
5	IO_L71P_5	AN24		
5	IO_L70N_5	AU25		
5	IO_L70P_5	AV25		
5	IO_L69N_5/VREF_5	AL24		
5	IO_L69P_5	AL23		
5	IO_L68N_5	AK23		
5	IO_L68P_5	AK24		
5	IO_L67N_5	AU27		
5	IO_L67P_5	AU26		
5	IO_L60N_5	AP25		
5	IO_L60P_5	AP24		
5	IO_L59N_5	AM24		
5	IO_L59P_5	AM25		
5	IO_L58N_5	AW28		
5	IO_L58P_5	AW27		
5	IO_L57N_5/VREF_5	AT27		
5	IO_L57P_5	AT26		
5	IO_L56N_5	AH23		
5	IO_L56P_5	AH24		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	VCCINT	R19		
NA	VCCINT	R18		
NA	VCCINT	R17		
NA	VCCINT	R16		
NA	VCCINT	R15		
NA	VCCINT	P26		
NA	VCCINT	P20		
NA	VCCINT	P14		
NA	VCCINT	N27		
NA	VCCINT	N20		
NA	VCCINT	N13		
NA	GND	AW38		
NA	GND	AW37		
NA	GND	AW20		
NA	GND	AW3		
NA	GND	AW2		
NA	GND	AV39		
NA	GND	AV38		
NA	GND	AV37		
NA	GND	AV29		
NA	GND	AV11		
NA	GND	AV3		
NA	GND	AV2		
NA	GND	AV1		
NA	GND	AU39		
NA	GND	AU38		
NA	GND	AU37		
NA	GND	AU3		
NA	GND	AU2		
NA	GND	AU1		
NA	GND	AT36		
NA	GND	AT23		
NA	GND	AT20		
NA	GND	AT17		
NA	GND	AT4		
NA	GND	AR35		

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
2	VCCO_2	N12	
2	VCCO_2	P3	
2	VCCO_2	P8	
2	VCCO_2	P11	
2	VCCO_2	P12	
2	VCCO_2	R11	
2	VCCO_2	R12	
3	VCCO_3	U11	
3	VCCO_3	U12	
3	VCCO_3	V3	
3	VCCO_3	V8	
3	VCCO_3	V11	
3	VCCO_3	V12	
3	VCCO_3	W11	
3	VCCO_3	W12	
3	VCCO_3	Y11	
3	VCCO_3	AB6	
3	VCCO_3	AE3	
4	VCCO_4	Y13	
4	VCCO_4	Y14	
4	VCCO_4	Y15	
4	VCCO_4	AA12	
4	VCCO_4	AA13	
4	VCCO_4	AA14	
4	VCCO_4	AA15	
4	VCCO_4	AD14	
4	VCCO_4	AF10	
4	VCCO_4	AJ7	
4	VCCO_4	AJ14	
5	VCCO_5	Y17	
5	VCCO_5	Y18	
5	VCCO_5	Y19	
5	VCCO_5	AA17	
5	VCCO_5	AA18	
5	VCCO_5	AA19	
5	VCCO_5	AA20	
5	VCCO_5	AD18	
5	VCCO_5	AF22	